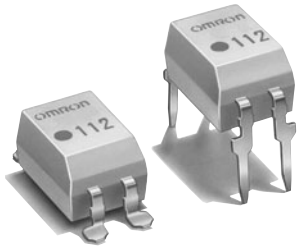
G3VM-401A/D

MOS FET Relays

Expanded Range of Analog-switching MOS FET Relays with 400-V Load Voltage.

- **Continuous load current of 120 mA.**
- **Dielectric strength of 2,500 Vrms between I/O.**

RoHS compliant

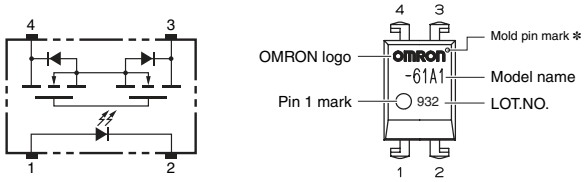


Note: The actual product is marked differently from the image shown here.

■ Application Examples

- **Test & Measurement equipment**
- **Security equipment**
- **Amusement equipment**

■ Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.
✻ The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

■ List of Models

Package type	Contact form	Terminals	Load voltage (peak value) ✻	Model	Minimum package quantity	
					Number per tube	Number per tape and reel
DIP4	1a (SPST-NO)	PCB Terminals	400 V	**G3VM-401A**	100	-
		Surface-mounting Terminals		**G3VM-401D**		
				G3VM-401D (TR)	-	1,500

✻ The AC peak and DC value are given for the load voltage.

■ Absolute Maximum Ratings (Ta = 25°C)

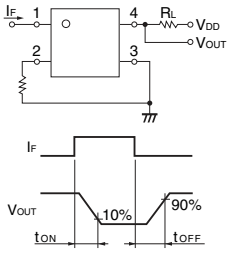
Item		Symbol	Rating	Unit	Measurement conditions
Input	**LED forward current**	I_F	50	mA	
	Repetitive peak LED forward current	I_{FP}	1	A	100 μs pulses, 100 pps
	LED forward current reduction rate	ΔIF/°C	−0.5	mA/°C	Ta ≥ 25°C
	LED reverse voltage	V_R	5	V	
	Connection temperature	T_J	125	°C	
Output	**Load voltage (AC peak/DC)**	V_{OFF}	400	V	
	Continuous load current (AC peak/DC)	I_O	120	mA	
	ON current reduction rate	ΔIo/°C	−1.2	mA/°C	Ta ≥ 25°C
	Connection temperature	T_J	125	°C	
Dielectric strength between I/O (See note 1.)		V_{I-O}	2500	Vrms	AC for 1 min
Ambient operating temperature		Ta	−40 to +85	°C	With no icing or condensation
Ambient storage temperature		Tstg	−55 to +125	°C	With no icing or condensation
Soldering temperature		-	260	°C	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

■ Electrical Characteristics (Ta = 25°C)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	**LED forward voltage**	V_F	1.0	1.15	1.3	V	I_F = 10 mA
	Reverse current	I_R	-	-	10	μA	V_R = 5 V
	Capacity between terminals	C_T	-	30	-	pF	V = 0, f = 1 MHz
	Trigger LED forward current	I_{FT}	-	1	3	mA	Io = 120 mA
Output	Maximum resistance with output ON	R_{ON}	-	18	35	Ω	I_F = 5 mA, Io = 120 mA
	Current leakage when the relay is open	I_{LEAK}	-	-	1.0	μA	V_{OFF} = 400 V
	Capacity between terminals	C_{OFF}	-	40	-	pF	V = 0, f = 1 MHz
Capacity between I/O terminals		C_{I-O}	-	0.8	-	pF	f = 1 MHz, V_S = 0 V
Insulation resistance between I/O terminals		R_{I-O}	1000	-	-	MΩ	V_{I-O} = 500 VDC, RoH ≤ 60%
Turn-ON time		t_{ON}	-	-	1.0	ms	I_F = 5 mA, R_L = 200 Ω, V_{DD} = 20 V(See note 2.)
Turn-OFF time		t_{OFF}	-	-	1.0	ms	

Note: 2. Turn-ON and Turn-OFF Times



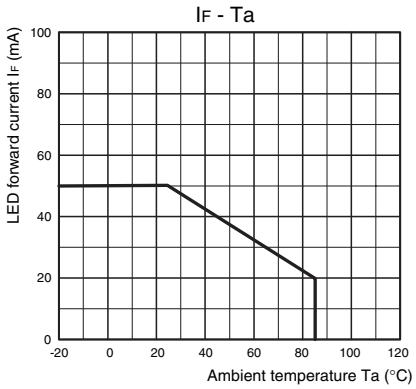
■ Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

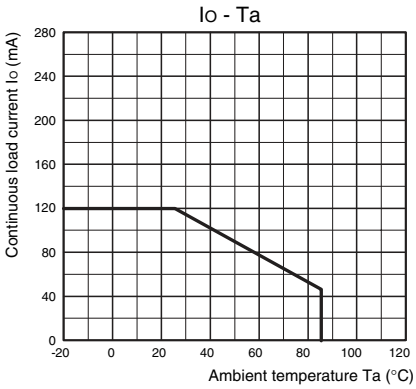
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V_{DD}	-	-	320	V
Operating LED forward current	I_F	5	7.5	25	mA
Continuous load current (AC peak/DC)	I_O	-	-	100	mA
Ambient operating temperature	Ta	–20	-	65	°C

■ Engineering Data

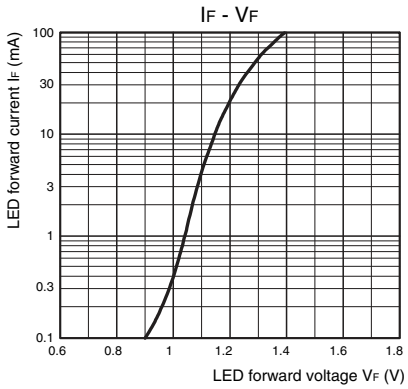
LED forward current vs. Ambient temperature



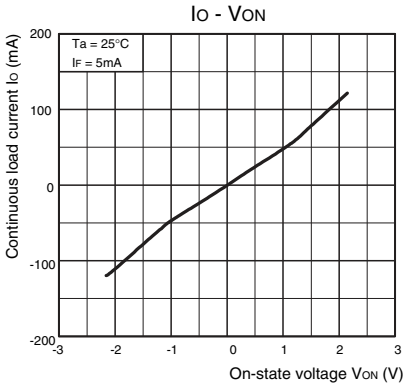
Continuous load current vs. Ambient temperature



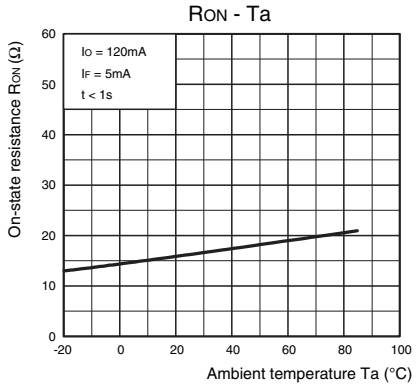
LED forward current vs. LED forward voltage



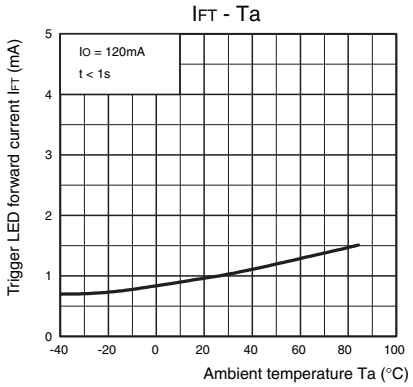
Continuous load current vs. On-state voltage



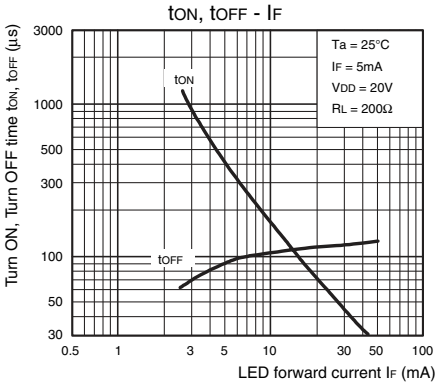
On-state resistance vs. Ambient temperature



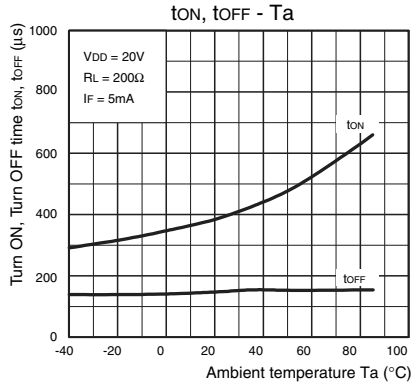
Trigger LED forward current vs. Ambient temperature



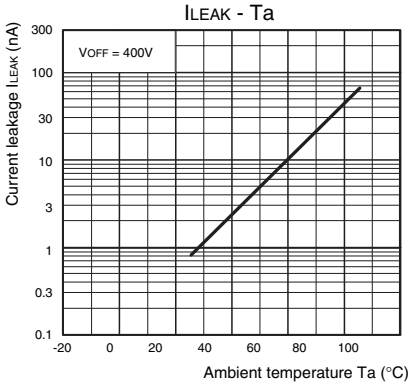
Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Ambient temperature



■ Safety Precautions

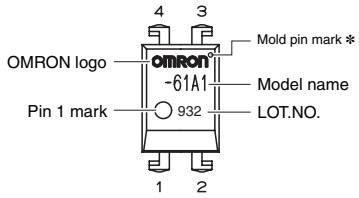
- Refer to **"Common Precautions"** for all G3VM models.

Appearance/Dimensions DIP4 type

■ Appearance

DIP (Dual Inline Package)

DIP4



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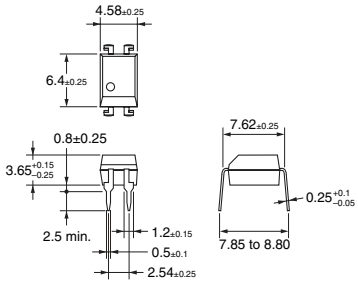
■ Dimensions

(Unit:mm)

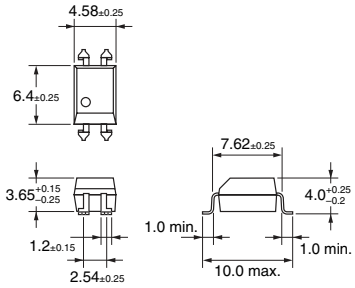
PCB Terminals

Weight: 0.25 g

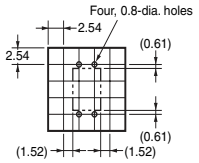


Surface-mounting Terminals

Weight: 0.25 g

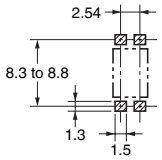


PCB Dimensions (BOTTOM VIEW)



Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)



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OMRON Corporation

ELECTRONIC AND MECHANICAL COMPONENTS COMPANY **Contact: www.omron.com/ecb**

Cat. No. K149-E1-01

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